



**DMN2050L** 

#### **N-CHANNEL ENHANCEMENT MODE MOSFET**

#### **Features**

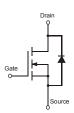
- Low On-Resistance
  - $29m\Omega @V_{GS} = 4.5V$
  - $50m\Omega @V_{GS} = 2.5V$
  - 100mΩ @ $V_{GS}$  = 2.0V
- Very Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.008 grams (approximate)

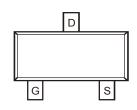






SOT23

**Equivalent Circuit** 



Top View

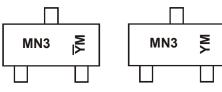
### Ordering Information (Note 4)

Part Number	Case	Packaging
DMN2050L-7	SOT23	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



Chengdu A/T Site Shanghai A/T Site MN3 = Marking Code

YM = Date Code Marking for SAT (Shanghai Assembly/ Test site) YM = Date Code Marking for CAT (Chengdu Assembly/ Test site)

Y or  $\overline{Y}$  = Year (ex: A = 2013)

M = Month (ex: 9 = September)

Data Coda Kay

Year	2008		2009	2010		2011	2012		2013	2014		2015
Code	V		W	X		Υ	Z		Α	В		С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units
Drain-Source Voltage	$V_{DSS}$	20	V
Gate-Source Voltage	$V_{GSS}$	±12	V
Drain Current (Note 5)	I <sub>D</sub>	5.9	Α
Pulsed Drain Current (Note 6)	I <sub>DM</sub>	21	A

## **Thermal Characteristics**

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 5)	P <sub>D</sub>	1.4	W
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>0JA</sub>	90	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

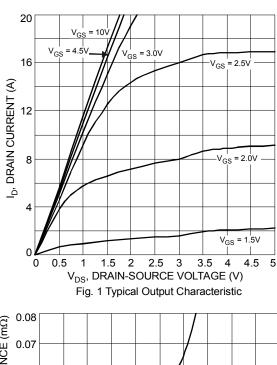
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)			•	•		•	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	_	_	V	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μΑ	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(th)</sub>	0.45	_	1.4	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
		_	24	29 50 100	mΩ	$V_{GS} = 4.5V, I_D = 5.0A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>		42			$V_{GS} = 2.5V, I_D = 3.1A$	
			68			$V_{GS} = 2.0V, I_D = 1.5A$	
Forward Transfer Admittance	Y <sub>fs</sub>	_	8	_	S	V <sub>DS</sub> =5V, I <sub>D</sub> = 2.1A	
Diode Forward Voltage (Note 7)	V <sub>SD</sub>	_	0.9	1.4	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 2.0A	
DYNAMIC CHARACTERISTICS (Note 8)			-	-	-		
Input Capacitance	C <sub>iss</sub>	_	532	_	pF		
Output Capacitance	Coss		144	_	pF	$V_{DS} = 10V, V_{GS} = 0V$ $f = 1.0MHz$	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	117	_	pF	1.5(1)	
Gate Resistance	$R_G$	_	1.3	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
SWITCHING CHARACTERISTICS (Note 8)							
Total Gate Charge	Qg	_	6.7	_		$V_{DS}$ = 10V, $V_{GS}$ = 4.5V, $I_{D}$ = 5.0A	
Gate-Source Charge	Q <sub>gs</sub>	_	0.8	_	nC	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 5.0A	
Gate-Drain Charge	Q <sub>gd</sub>	_	3.0	_		V <sub>DS</sub> = 10V, V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 5.0A	

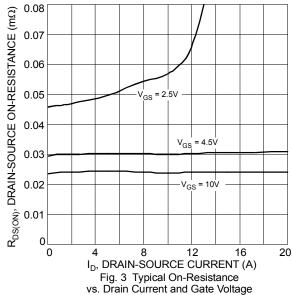
Notes:

- 5. Device mounted on FR-4 PCB, on 2oz Copper pad layout with  $R_{\theta JA} = 90^{\circ}$ C/W.

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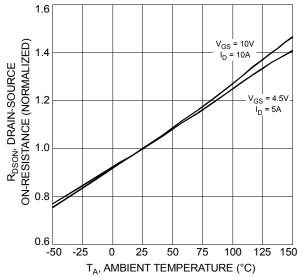
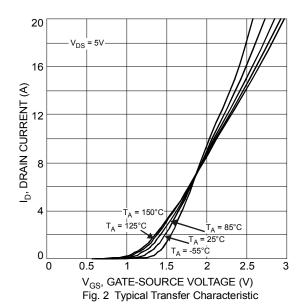
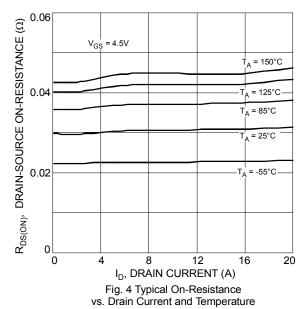


Fig. 5 On-Resistance Variation with Temperature





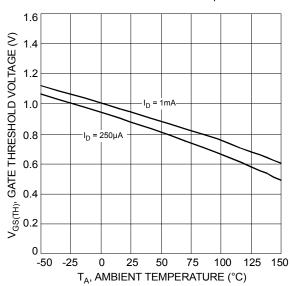
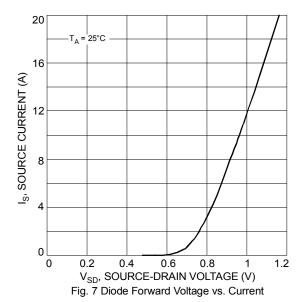
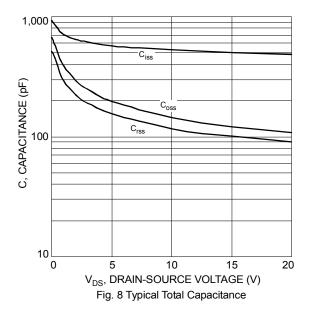


Fig. 6 Gate Threshold Variation vs. Ambient Temperature







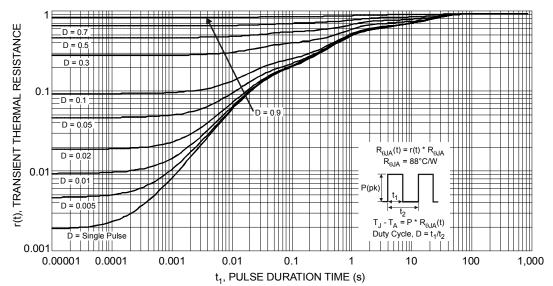
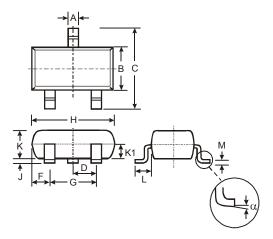


Fig. 9 Transient Thermal Response



# **Package Outline Dimensions**

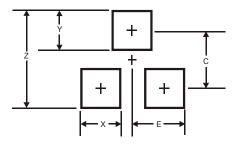
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	SOT23							
Dim	Min	Max	Тур					
Α	0.37	0.51	0.40					
В	1.20	1.40	1.30					
С	2.30	2.50	2.40					
D	0.89	1.03	0.915					
F	0.45	0.60	0.535					
G	1.78	2.05	1.83					
Н	2.80	3.00	2.90					
J	0.013	0.10	0.05					
K	0.903	1.10	1.00					
K1	-	-	0.400					
L	0.45	0.61	0.55					
M	0.085	0.18	0.11					
α	0°	8°	-					
All	All Dimensions in mm							

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35



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